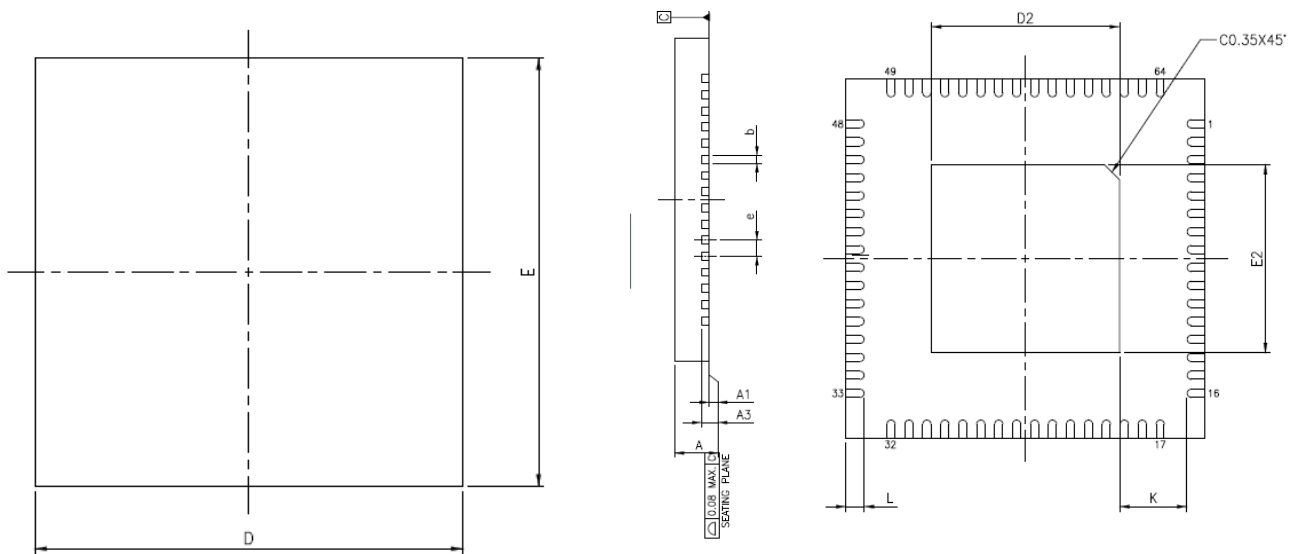


Package Dimension

QFN- 64 (8x8x0.75) (with heat sink)



mm							inch					
JEDEC	MO-220			MO-220			MO-220			MO-220		
PKG CODE	WQFN(X864)			VQFN(Y864)			WQFN(X864)			VQFN(Y864)		
Symbols	Min.	Nom.	Max.	Min.	Nom.	Max.	Min.	Nom.	Max.	Min.	Nom.	Max.
A	0.70	0.75	0.80	0.80	0.85	0.90	0.027	0.029	0.031	0.031	0.033	0.035
A1	0.00	0.02	0.05	0.00	0.02	0.05	0.000	0.000	0.001	0.000	0.000	0.001
A3	0.203 REF.			0.203 REF.			0.007 REF.			0.007 REF.		
b	0.15	0.20	0.25	0.15	0.20	0.25	0.005	0.007	0.009	0.005	0.007	0.009
D	8.00 BSC			8.00 BSC			0.314 BSC			0.314 BSC		
E	8.00 BSC			8.00 BSC			0.314 BSC			0.314 BSC		
e	0.40 BSC			0.40 BSC			0.015 BSC			0.015 BSC		
L	0.35	0.40	0.45	0.35	0.40	0.45	0.013	0.015	0.017	0.013	0.015	0.017
K	0.20	---	---	0.20	---	---	0.007	---	---	0.007	---	---

PAD SIZE	E2			D2			LEAD FINISH		JEDEC CODE
	Min.	Nom.	Max.	Min.	Nom.	Max.	Pure Tin	PPF	
181x18MIL	4.15	4.20	4.25	4.15	4.20	4.25	V	X	N/A
268x26MIL	6.40	6.50	6.60	6.40	6.50	6.60	V	X	W(V)LLE-2

此為參考尺寸，各型號 IC 請參閱 data sheet

This is the dimension for reference ,see the data sheet for the exact dimension for each model of IC.